

/ Descriptions

/ Features

/ Applications

/ Equivalent Circuit



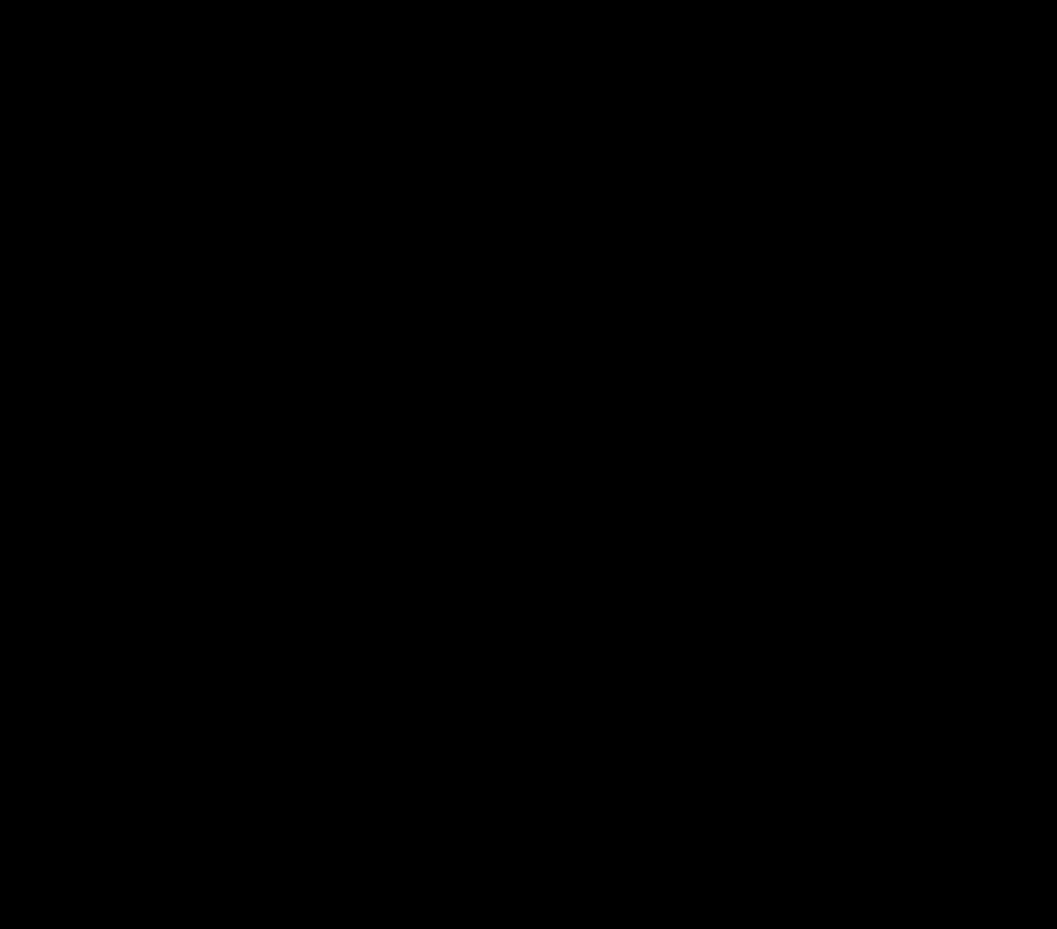
/ Pinning



/ h_{FE} Classifications & Marking

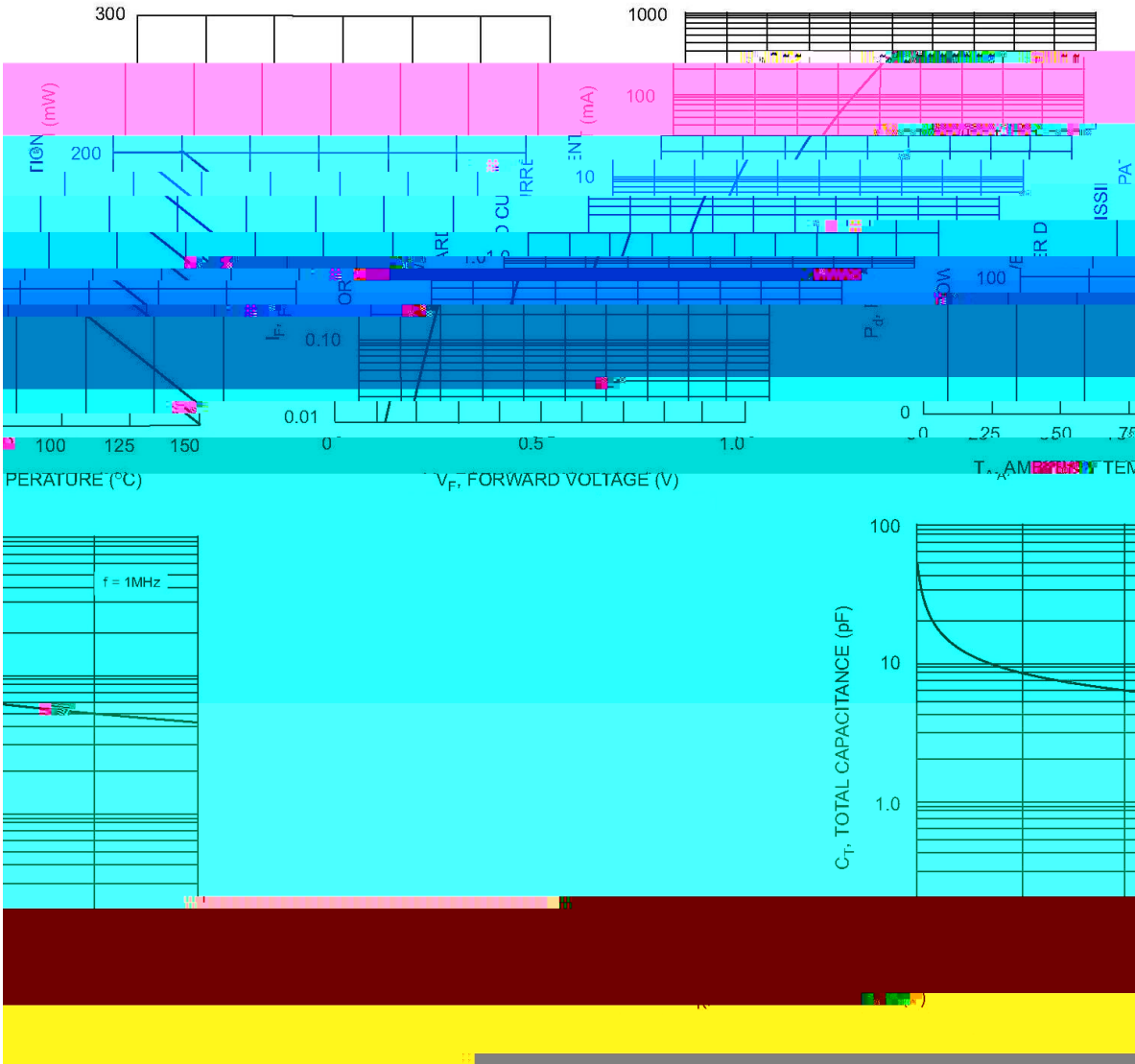
	θ				

		μ				

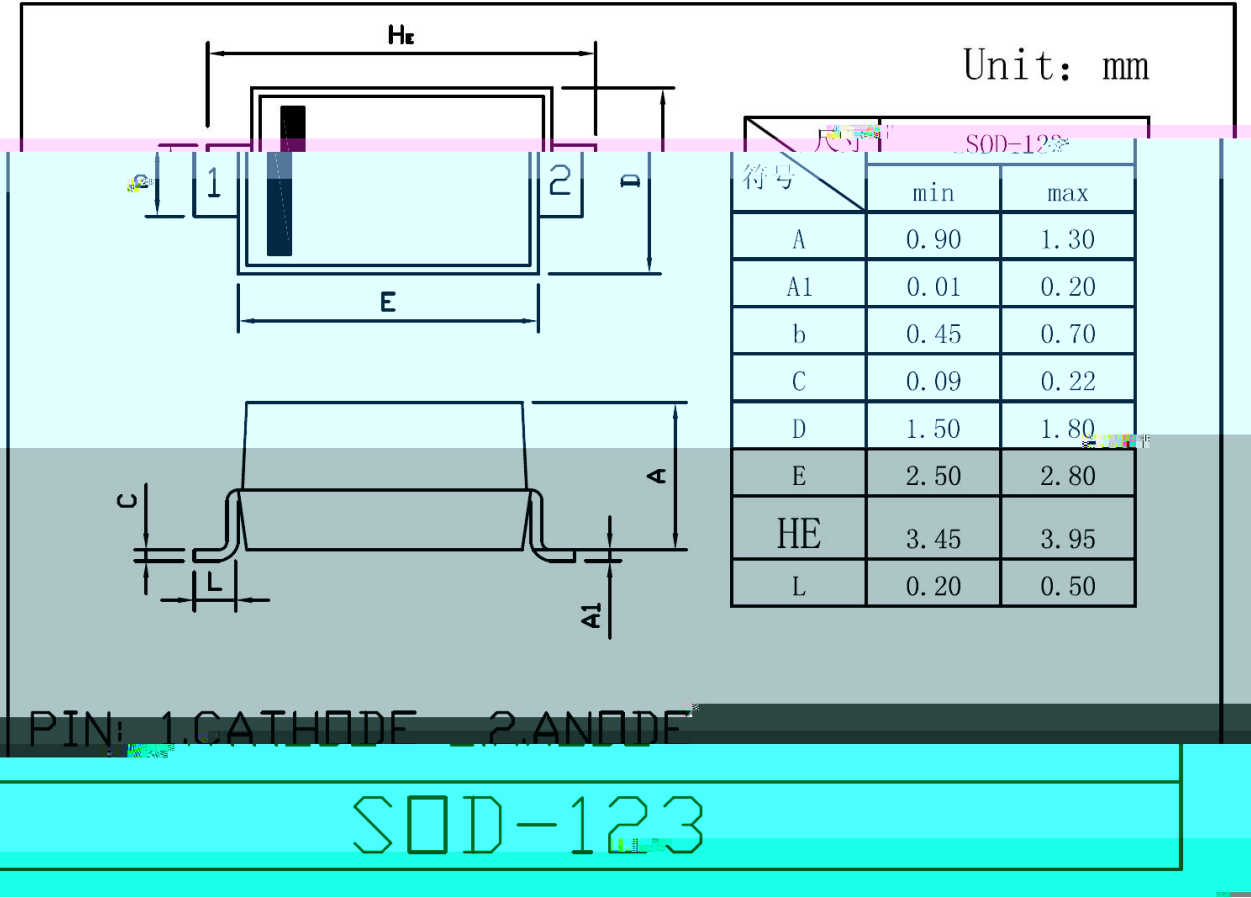


μ

/ Electrical Characteristic Curve



/ Package Dimensions

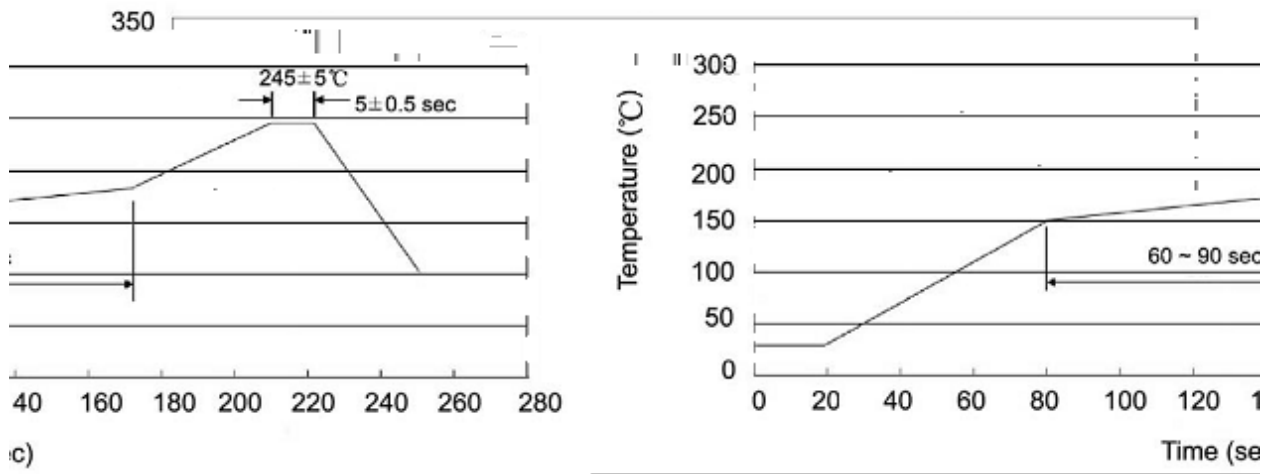


/ Marking Instructions



H
S5

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

/ Notices